Lowering of The Sintering Temperature of High Thermal Conductive AlN Ceramics

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Abstract

High thermal conductivity of aluminum nitride (AlN) was attained by using suitable amount of additives such as oxides and fluorides. Additives such as CaO, Y_2O_3 , CaF₂, YF₃ and AlF₃ were investigated as AlN sintering aids, aiming at lowering the sintering temperature. AlN ceramics were sintered at 1600°C using a mixture of CaO, CaF₂ and AlF₃ additives. The thermal conductivity of AlN with CaO-AlF₃, CaF₂-AlF₃, additives was found to be 160W·m⁻¹K⁻¹.

Key-words: aluminum nitride, sintering, additives, thermal conductivity, oxides, fluorides

Introduction

Aluminum nitride (AlN) is known as a high thermal conductive ceramics. Its monocrystal conductivity is about $320W \cdot m^{-1}K^{-1}$. However, it is difficult to process AlN ceramics and achieve high thermal conductivity. The thermal conductivity of AlN ceramics is reduced by the presence of impurities such as oxygen and transition metal ions²⁾ in the ceramics, and pressureless sintering is inefficient in producing pure AlN. Thus, AlN is usually sintered with a suitable amount of additives such as oxides³⁾ and fluorides^{4.5)}, which promote liquid phase sintering. The liquid phase is produced by the reaction of Al_2O_3 that exists on the surface of AlN particles. For example, Y_2O_3 additive reacts with Al_2O_3 producing the Y-Al-O liquid phase which then promotes the sintering of AlN. CaO, YF_3 and CaF₂ additives also produce similar effects. This liquid phase migrates through grain boundaries and concentrates at grain boundary triple points, or migrates to the surface of the sintered AlN body⁵⁾. This means that these additives can either trap or remove oxygen impurity at the grain boundary triple points. Moreover, it was reported that sintering in N_2 and reducing carbon gas atomosphere brought about good results in the removal of impurity phases. By using this method, the high thermal conductivity of AlN appears. Usually, AlN ceramics were sintered at more than 1800°C in N₂ gas atmosphere including reducing carbon gas. But, from commercial points of view it is better to make the sintering temperature low for energy cost. Thus, we investigated the sintering of CaO, Y_2O_3 , CaF₂, YF_3 and AIF_3 additives, for the purpose of lowering the sintering temperature of AlN ceramics. The effect of AlF₃ addition was investigated due to the fact that it decomposes at a low temperature (about 1300°C) and dose not become an impurity in AlN ceramics.

This paper reports the comparison of these additives and the effect of AlF_{\exists} addition.

Experimental

1. Sample preparation

The samples were fabricated by means of the conventional procedure as follows; the starting materials are AlN (Tokuyama Soda Co.,Ltd., F grade; oxygen content \leq 1.0%, average grain size 1.8 μ m) Y₂O₃, YF₃, CaO, CaF₂

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(Soekawa chemicals Co.,Ltd., purity 3N) and AlF₃ powders (High Purity Chemicals Co.,Ltd., purity 3N). These powders were weighed (Table 1) and mixed in ethanol with nylon ball for 4 hours. Slurry substances were obtained. These slurries were dried and acrylic binder was added. The mixture was again mixed in 1-1-1 tri-chloro-ethane. After drying, the mixed powders were pressed into 12mm diameter discs under the pressure of about 500kg/cm². The samples were heated at 700°C in flowing N₂ gas in order to burn out the binder. After this treatment, the samples were sintered at 1500, 1600, 1700 and 1800°C for 2, 4, 8, 16 and 32 hours in N₂ atmosphere.

2. Evaluation

Dielectric constants of sintered samples were measured by the conventional method, and their densities were measured by the Archimedian method. Thermal conductivities were measured by the laser-flash method using a ruby laser (λ =0.6943mm) and liquid-nitrogen-cooled InSb infrared detector at room temperature. The sintered samples were identified by the X-ray powder diffraction method (XRD) after crushing in an agate mortar. The microstructures were observed by scanning electron microscope (SEM), and X-ray photoelectron spectroscopy (XPS) was applied to investigate the fluoride.

Results and discussion

The changes in the density and the thermal conductivity of the materials sintered at a temperature range of 1500-1800°C for 4 hours are shown in Figs. 1 and 2. As shown in Fig.1, added materials such as Y_2O_3 , YF_3 , Y_2O_3 -AlF₃ and YF_3 -AlF₃ densified at T > 1700 °C, and the thermal conductivity of these materials increases with increasing sintering temperature. The materials with additives, Y_2O_3 -AlF₃ and YF_3 -AlF₃, showed higher thermal conductivity than those materials without AlF₃ when sintered at T > 1700°C. This gives an information on the influence of the AlF₃ additive. Figure 2 shows the materials with additives, CaO, CaF₂, CaO-AlF₃ and CaF₂-AlF₃. As shown in this figure, there is a similar tendency on the density of these materials, however densification started at 1600°C. This temperature is lower than that of Fig.1. The thermal conductivity of the materials with AlF₃ is higher than those materials without AlF₃. From the above observations, additives such as CaO and CaF₂ may be useful for low temperature sintering, and the additive AlF₃ may give some good influence on the liquid-phase sintering. Higher thermal conductivity was obtained in the AlN-CaO-AlF₃ and AlN-CaF₂-AlF₃ systems.

Figure 3 summarizes the microstructural evalution of materials with CaO and CaO-AlF₃ addition. These materials were sintered at temperature $1500-1700^{\circ}$ for 4 hours. The microstructures of the fractured surface of the samples with CaO addition are shown in Fig.3 a)-c), and those with CaO-AlF₃ addition are shown in Fig.3 d)-f). The materials shown in Fig.3 a) and d) were sintered at 1500° . Fig.3 b) and e) show the materials sintered at 1600° and Fig.3 c) and f) at 1700° . Both samples sintered at 1500° C and the sample with CaO addition shown in Fig.3 b) were all porous. On the other hand, the sample with CaO-AlF₃ addition shown in Fig.3 e) and both of the samples sintered at 1700° showed no pores. It was found that the particle size of the sample with CaO-AlF₃ addition is larger than that of the sample with CaO addition sintered at same temperature, as shown in Fig.3 a)-f). Thus, the grain growth may be promoted in the AlN-CaO-AlF₃ system.

Crystallographic phases of sintered samples are listed in Table 2. The crystallographic phase of the samples with Y_2O_3 and Y_2O_3 -AlF₃ addition were found to be similar to $Y_4Al_2O_3$. This phase is the liquid phase during

sintering. This means that same sintering system may be promoted in the AlN body in spite of AlF_3 addition. A similar phase was observed in the samples with CaO and CaO-AlF₃ additive.

AlF₃ is known as a material that decomposes at approximately 1300°C. XPS measurements were carried out for three samples with CaO-AlF₃ addition, which were sintered at 1300, 1400 and 1600°C. The samples sintered at 1300 and 1400°C were observed at the polished surface, and the sample sintered at 1600°C was observed at the polished and fractured surface. Figure 4 shows the XPS analysis of the material sintered at 1400°C. Fluorine was detected at this temperature. The same result was observed in the sample sintered at 1300°C. This is the information that fluorine exists as the same state in the AlN body. But, it is found out that fluorine disappears at higher than 1400°C. Fluorine was not detected on the polished and on the fractured surface of the sample sintered at 1600°C.

Figure 5 shows the relations between the thermal conductivity and holding time of the materials with CaO, CaF_2 , $CaO-AlF_3$ and CaF_2-AlF_3 addition sintered at 1600°C. The thermal conductivity of each materials increased with increasing the holding time. However, at saturated value, they showed some difference between the samples with AlF_3 and without AlF_3 . AlF_3 additive may be effective in the initial stage of sintering.

Dielectric constant of the materials with CaO-AlF₃ addition is shown in Table 3. It was measured in the following condition; 1MHz, at room temperature. The values obtained are close to the value of Al_2O_3 (8.5 at R.T. 1MHz).

Conclusion

CaO, CaF₂ are effective additives for the low temperature $(1600 \,^{\circ}\text{C})$ sintering of AlN ceramics. Doping AlF₃ with CaO or CaF₂ increases thermal conductivity. Thermal conductivity of $160W \cdot m^{-1}K^{-1}$ has been obtained in sintering AlN-CaO-AlF₃ at 1600°C for 32 hours.

Fluorine decomposes and may go out of the body by evaporation or some other way. Thus it may influence the liquid-phase sintering in the initial stage of the process.

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Sample	Additives & Content			(wt%)
1	Y203	3wt%,		
2	YF3	3wt%,		
3	CaO	1wt%,		
4	CaFz	1wt%,		
5	Y ₂ 03	3wt%,	AlF3	1wt%
6	YF3	3wt%,	AlF3	lwt%
7	Ca0	1wt%,	AlF3	1wt%
8	CaFz	1wt%,	AlFa	1wt%

Table 1 Additive content in AlN

Table 2. Crystallographic phases of sintered samples

additives	Cryst	Crystallographic phase		
Y ₂ O ₃ , AlF ₃	A1N,	Y ₄ Al ₂ O ₂ ,	YN	
Y ₂ O ₃	A1N,	Y ₄ Al ₂ O ₂ ,	YN	
CaO, AlF ₃	A1N,	CaAl ₂ O ₄ ,	CaAl₄O7	
CaO	A1N,	CaAl ₂ O ₄ ,	CaAl₄O7	

Table 3. Dielectric Constant (1MHz)

Sintering condition	Dielectric constant		
1600 ℃, 4 hours	9.4		
1600°C, 8 hours	9.3		
1600°C, 16 hours	9.1		
1800°C, 4 hours	9.0		



Figure 1 Thermal conductivity and density of AlN ceramics with Y_2O_3 , YF_3 and AlF₃. O: Y_2O_3 , \bigoplus : Y_2O_3 -AlF₃, \square : YF_3 , \blacksquare : YF_3 -AlF₃



Figure 2 Thermal conductivity and density of AlN ceramics with CaO, CaF₂ and AlF₃. \triangle :CaO, \blacktriangle :CaO-AlF₃, \bigtriangledown :CaF₂, \blacktriangledown :CaF₂-AlF₃

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a) Sintering temp:1500°C, Additive:CaO

b) Sintering temp:1600°C, Additive:CaO



c) Sintering temp:1700°C, Additive:CaO



d) Sintering temp:1500°C, Additives:CaO, AlF₃



e) Sintering temp:1600°C, Additives:CaO, AlF₃



f) Sintering temp:1700°C, Additives:CaO, AlFa



 $= 1.0 \,\mu m$

Figure 3 Microstructure of sintered AlN.







Figure 5 Thermal conductivity of AlN ceramics sintered at 1600°C. \triangle :CaO, \blacktriangle : CaO-AlF₃, \bigtriangledown :CaF₂, \forall :CaF₂-AlF₃